

Complementary N- and P-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY				
	V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ)
N-Channel	40	0.030 at V _{GS} = 10 V	8	9.6
		0.034 at V _{GS} = 4.5 V	8	
P-Channel	- 40	0.032 at V _{GS} = - 10 V	- 8	21
		0.041 at V _{GS} = - 4.5 V	- 8	

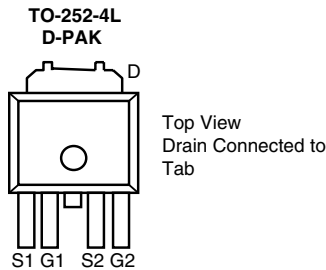
FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested

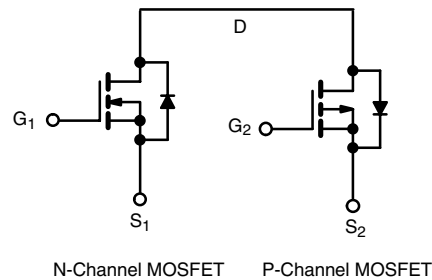


APPLICATIONS

- CCFL Inverter
- LCD TV and Monitor



Ordering Information: SUD50NP04-62-T4-E3 (Lead (Pb)-free)



ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted

Parameter	Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage	V _{DS}	40	- 40	V	
Gate-Source Voltage	V _{GS}	± 16			
Continuous Drain Current (T _J = 150 °C)	I _D	T _C = 25 °C	8	- 8	A
		T _C = 70 °C	8	- 8	
		T _A = 25 °C	8 ^{b, c}	- 8 ^{b, c}	
		T _A = 70 °C	8 ^{b, c}	- 8 ^{b, c}	
Pulsed Drain Current (10 μs Pulse Width)	I _{DM}	35	- 35	A	
Source-Drain Current Diode Current	I _S	T _C = 25 °C	8		- 8
		T _A = 25 °C	5 ^{b, c}	- 5.5 ^{b, c}	
Pulsed Source-Drain Current	I _{SM}	35	- 35	mJ	
Single Pulse Avalanche Current	I _{AS}	10	20		
Single Pulse Avalanche Energy	E _{AS}	5	20	W	
Maximum Power Dissipation	P _D	T _C = 25 °C	15.6		23.5
		T _C = 70 °C	10		15
		T _A = 25 °C	6 ^{b, c}		6.7 ^{b, c}
		T _A = 70 °C	3.9 ^{b, c}	4.3 ^{b, c}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS

Parameter	Symbol	N-Channel		P-Channel		Unit
		Typ	Max	Typ	Max	
Maximum Junction-to-Ambient ^{b, d}	R _{thJA}	17	20.5	15.2	18.5	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	6.6	8	4.4	5.3	

Notes:

- Based on T_C = 25 °C.
- Surface Mounted on 1" x 1" FR4 Board.
- t = 10 sec.
- Maximum under Steady State conditions is 53 °C/W (N-Channel) and 50 °C/W (P-Channel).

SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	N-Ch	40		V	
		$V_{GS} = 0\text{ V}, I_D = -250\text{ }\mu\text{A}$	P-Ch	-40			
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250\text{ }\mu\text{A}$	N-Ch		37		
		$I_D = -250\text{ }\mu\text{A}$	P-Ch		-38		
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250\text{ }\mu\text{A}$	N-Ch		-5		
		$I_D = -250\text{ }\mu\text{A}$	P-Ch		4.0		
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	N-Ch	0.6	2.0		
		$V_{DS} = V_{GS}, I_D = -250\text{ }\mu\text{A}$	P-Ch	-0.8	-2.2		
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 16\text{ V}$	N-Ch		100	nA	
			P-Ch		-100		
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 40\text{ V}, V_{GS} = 0\text{ V}$	N-Ch		1	μA	
		$V_{DS} = -40\text{ V}, V_{GS} = 0\text{ V}$	P-Ch		-1		
		$V_{DS} = 40\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$	N-Ch		10		
		$V_{DS} = -40\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$	P-Ch		-10		
On-State Drain Current ^b	$I_{D(on)}$	$V_{DS} = 5\text{ V}, V_{GS} = 10\text{ V}$	N-Ch	20		A	
		$V_{DS} = -5\text{ V}, V_{GS} = -10\text{ V}$	P-Ch	-20			
Drain-Source On-State Resistance ^b	$r_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 6\text{ A}$	N-Ch		0.025	0.030	Ω
		$V_{GS} = -10\text{ V}, I_D = -6\text{ A}$	P-Ch		0.026	0.032	
		$V_{GS} = 4.5\text{ V}, I_D = 4.8\text{ A}$	N-Ch		0.028	0.034	
		$V_{GS} = -4.5\text{ V}, I_D = -4.9\text{ A}$	P-Ch		0.034	0.041	
Forward Transconductance ^b	g_{fs}	$V_{DS} = 15\text{ V}, I_D = 6\text{ A}$	N-Ch		20	S	
		$V_{DS} = -15\text{ V}, I_D = -6\text{ A}$	P-Ch		17		
Dynamic^a							
Input Capacitance	C_{iss}	$V_{DS} = 20\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$ $V_{DS} = -20\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	N-Ch		855	μF	
			P-Ch		1505		
Output Capacitance	C_{oss}		N-Ch		105		
			P-Ch		230		
Reverse Transfer Capacitance	C_{rss}		N-Ch		65		
			P-Ch		175		
Total Gate Charge	Q_g	$V_{DS} = 20\text{ V}, V_{GS} = 10\text{ V}, I_D = 5\text{ A}$	N-Ch		21	32	nC
		$V_{DS} = -20\text{ V}, V_{GS} = -10\text{ V}, I_D = -5\text{ A}$	P-Ch		41	62	
Gate-Source Charge	Q_{gs}	$V_{DS} = 20\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 5\text{ A}$	N-Ch		9.6	14.5	
			P-Ch		21	31	
Gate-Drain Charge	Q_{gd}	$V_{DS} = -20\text{ V}, V_{GS} = -4.5\text{ V}, I_D = -5\text{ A}$	N-Ch		2.3		
			P-Ch		4.5		
Gate Resistance	R_g	$f = 1\text{ MHz}$	N-Ch		2.5	3.8	Ω
			P-Ch		6.5	10	



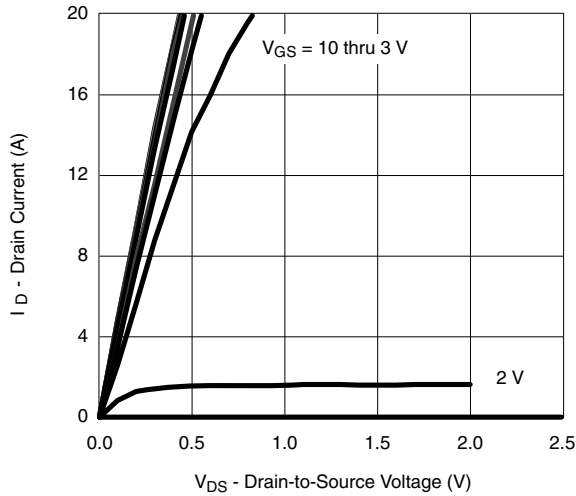
SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted							
Parameter	Symbol	Test Conditions		Min	Typ ^a	Max	Unit
Dynamic^a							
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 20\text{ V}, R_L = 4\ \Omega$ $I_D \cong 5\text{ A}, V_{GEN} = 10\text{ V}, R_g = 1\ \Omega$ P-Channel $V_{DD} = -20\text{ V}, R_L = 4\ \Omega$ $I_D \cong -5\text{ A}, V_{GEN} = -10\text{ V}, R_g = 1\ \Omega$	N-Ch		6	12	ns
			P-Ch		7	14	
Rise Time	t_r		N-Ch		21	32	
			P-Ch		23	35	
Turn-Off Delay Time	$t_{d(off)}$		N-Ch		24	36	
			P-Ch		51	77	
Fall Time	t_f		N-Ch		9	15	
			P-Ch		50	80	
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 20\text{ V}, R_L = 4\ \Omega$ $I_D \cong 5\text{ A}, V_{GEN} = 4.5\text{ V}, R_g = 1\ \Omega$ P-Channel $V_{DD} = -20\text{ V}, R_L = 4\ \Omega$ $I_D \cong -5\text{ A}, V_{GEN} = -4.5\text{ V}, R_g = 1\ \Omega$	N-Ch		12	20	
			P-Ch		40	60	
Rise Time	t_r		N-Ch		75	115	
			P-Ch		106	160	
Turn-Off Delay Time	$t_{d(off)}$		N-Ch		40	60	
			P-Ch		45	70	
Fall Time	t_f		N-Ch		56	85	
			P-Ch		50	75	
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I_S	$T_C = 25\text{ }^\circ\text{C}$	N-Ch			8	A
			P-Ch			-8	
Pulse Diode Forward Current ^a	I_{SM}		N-Ch			35	
			P-Ch			-35	
Body Diode Voltage	V_{SD}	$I_S = 1.5\text{ A}$ $I_S = -1.6\text{ A}$	N-Ch		0.73	1.2	V
			P-Ch		-0.73	-1.2	
Body Diode Reverse Recovery Time	t_{rr}	N-Channel $I_F = 5\text{ A}, di/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$ P-Channel $I_F = -5\text{ A}, di/dt = -100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$	N-Ch		26	40	ns
P-Ch			30	45			
Body Diode Reverse Recovery Charge	Q_{rr}		N-Ch		21	32	nC
			P-Ch		24	36	
Reverse Recovery Fall Time	t_a		N-Ch		13		ns
			P-Ch		15		
Reverse Recovery Rise Time	t_b	N-Ch		13			
		P-Ch		15			

Notes:

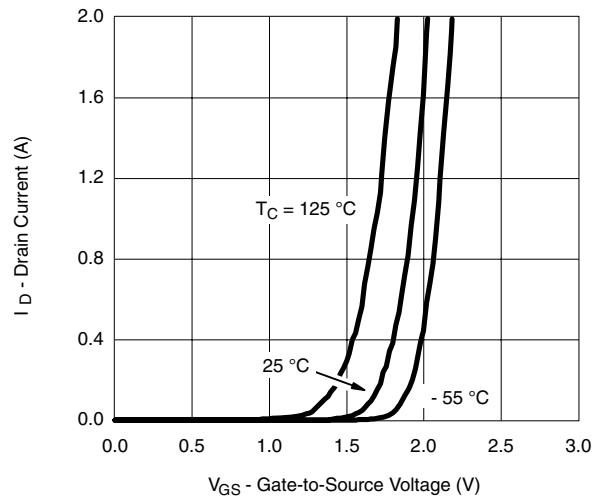
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

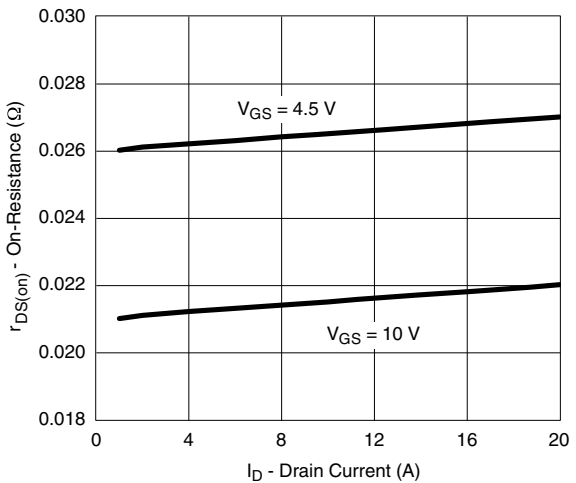
N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted



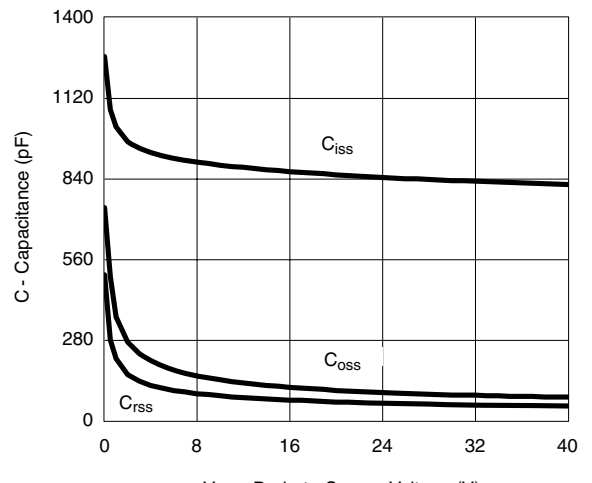
Output Characteristics



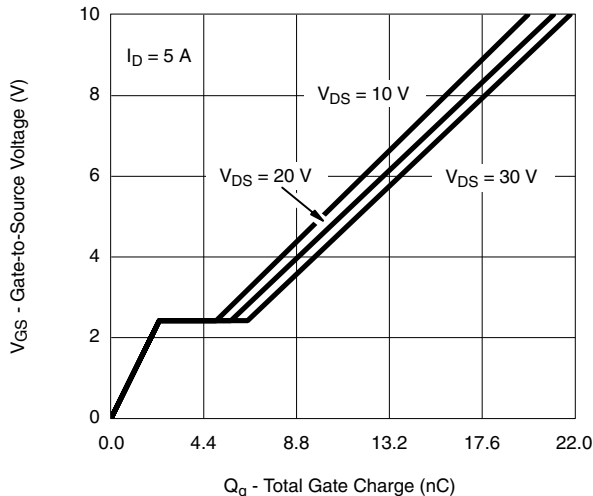
Transfer Characteristics



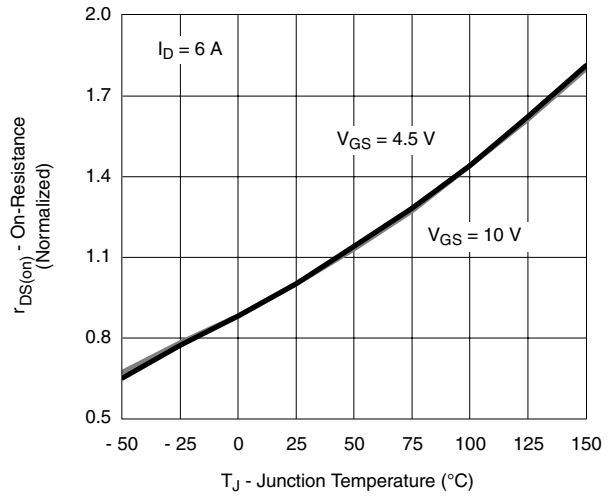
On-Resistance vs. Drain Current



Capacitance



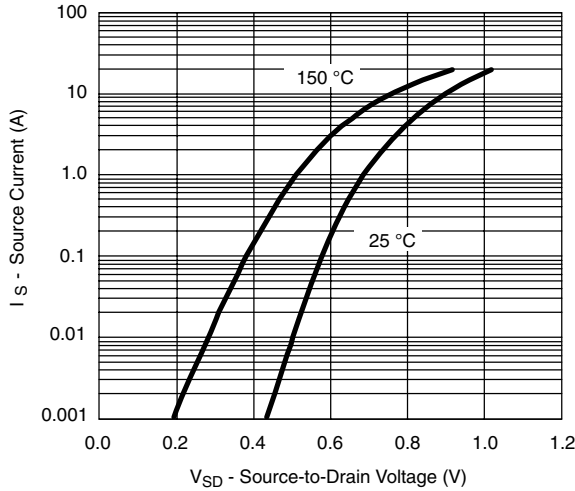
Gate Charge



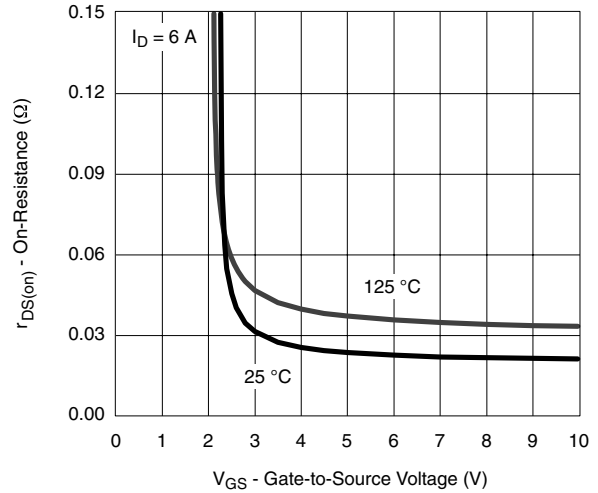
On-Resistance vs. Junction Temperature



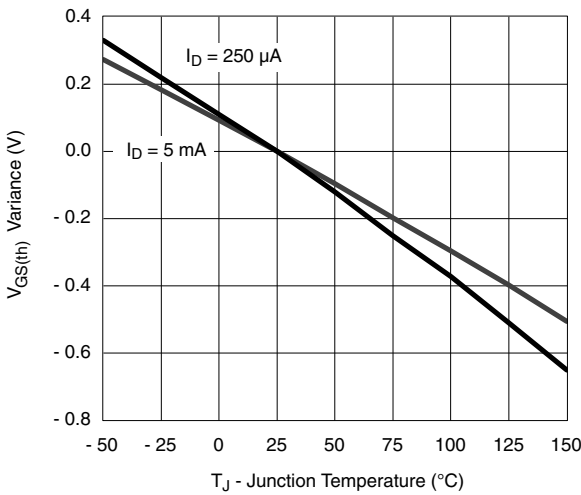
N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted



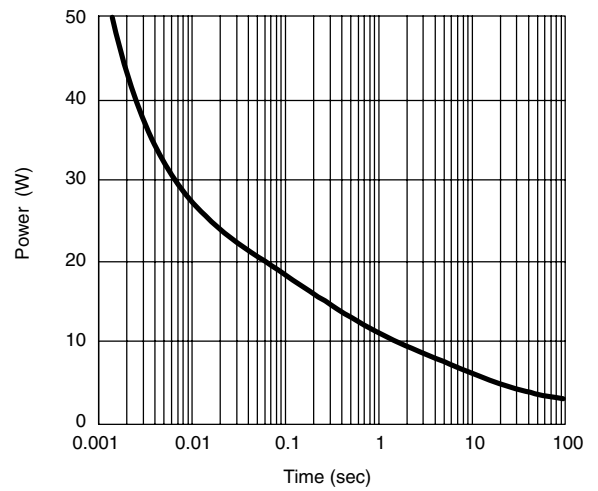
Source-Drain Diode Forward Voltage



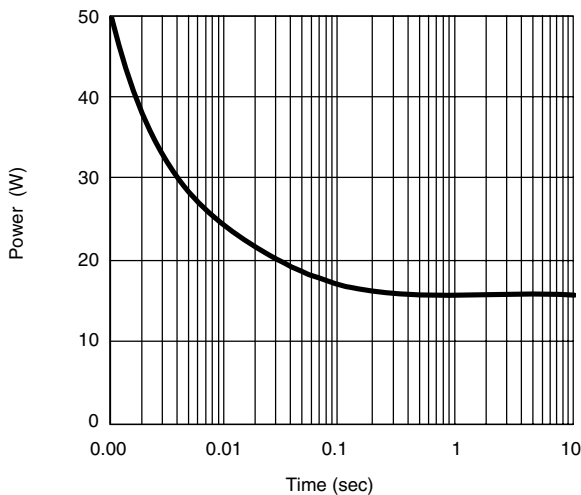
On-Resistance vs. Gate-to-Source Voltage



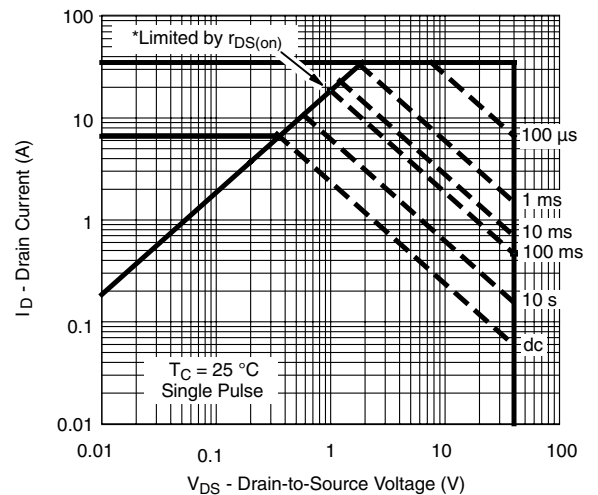
Threshold Voltage



Single Pulse Power, Junction-to-Ambient



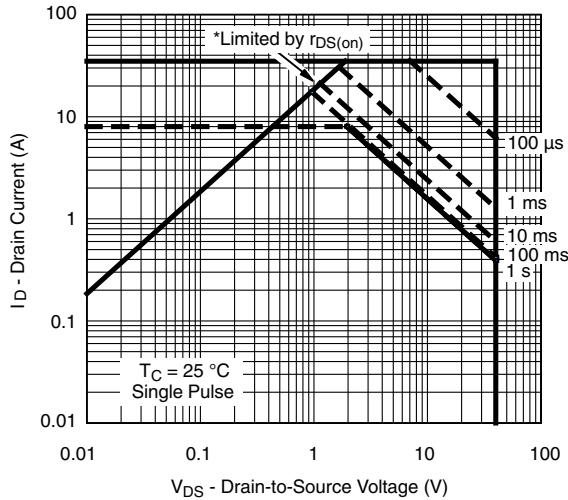
Single Pulse Power, Junction-to-Case



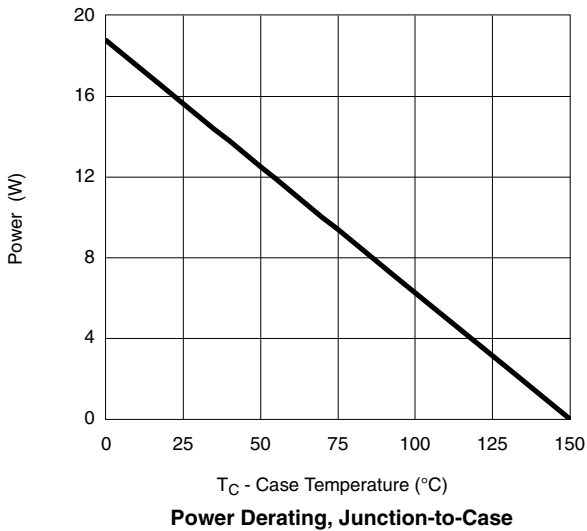
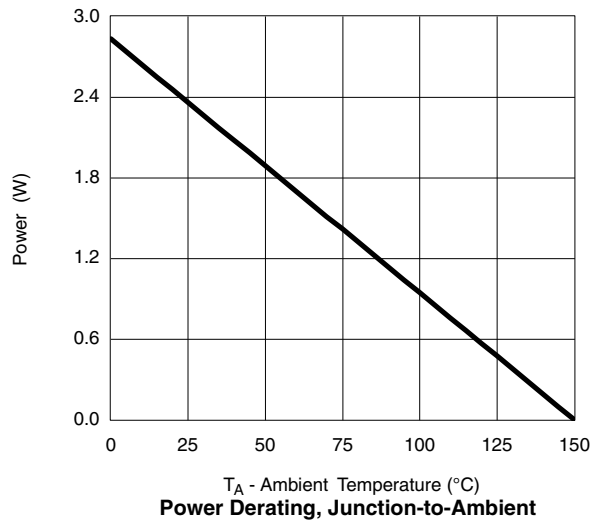
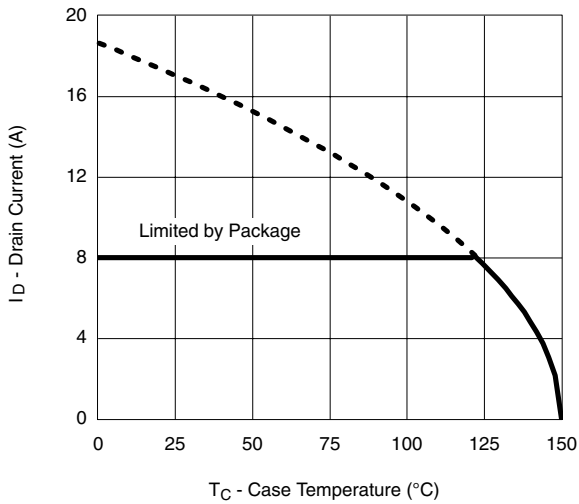
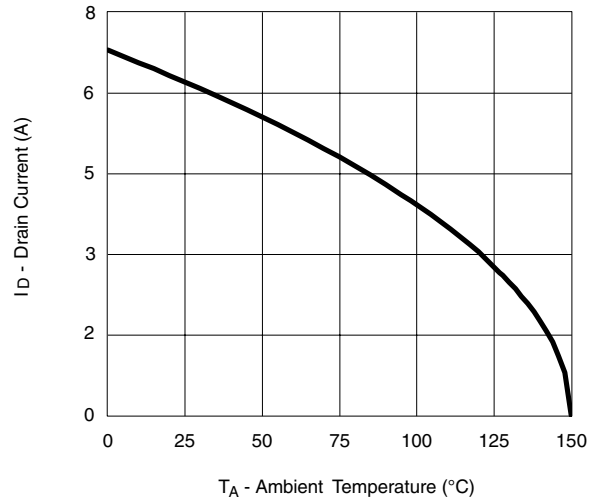
*V_{GS} > minimum V_{GS} at which r_{DS(on)} is specified

Safe Operating Area, Junction-to-Ambient

N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted

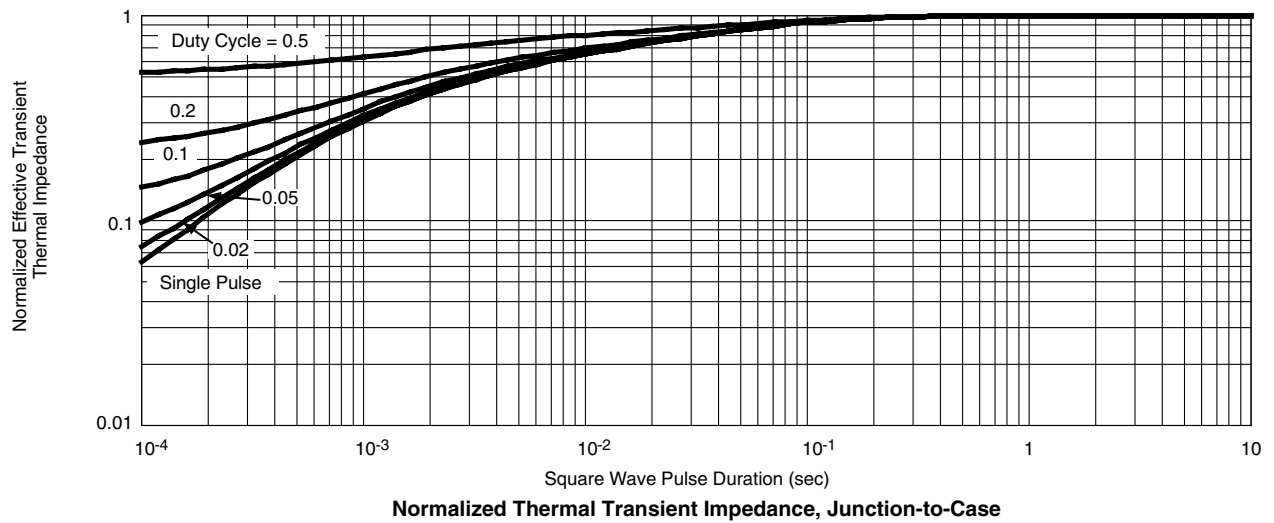
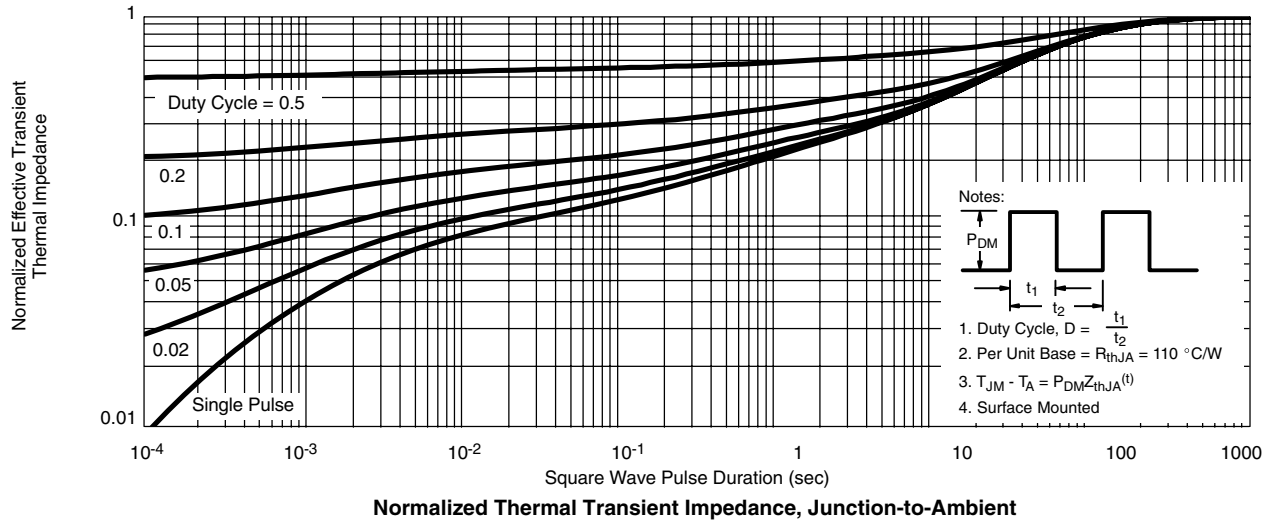


* $V_{GS} >$ minimum V_{GS} at which $r_{DS(on)}$ is specified

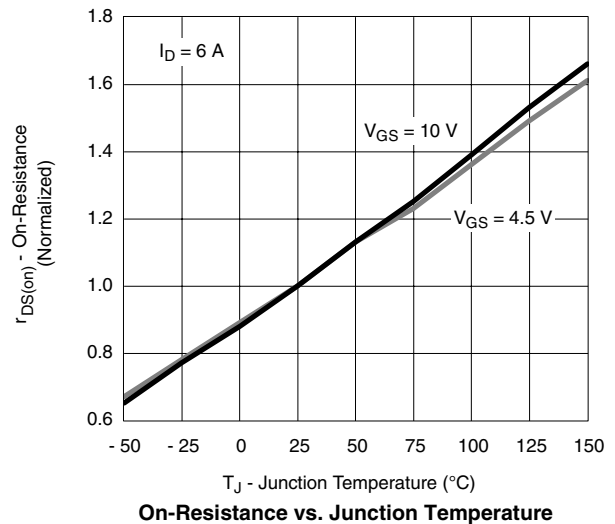
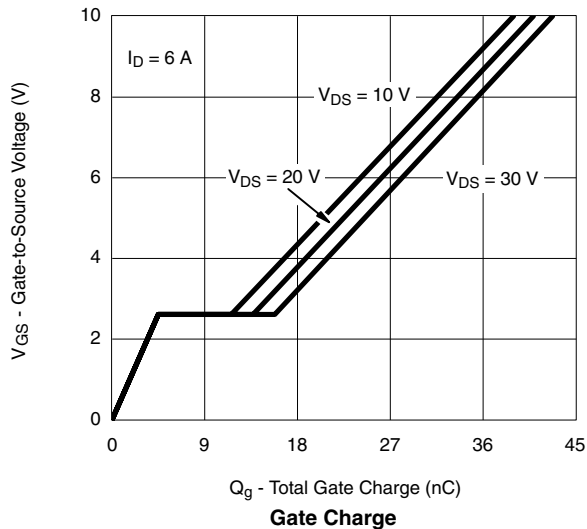
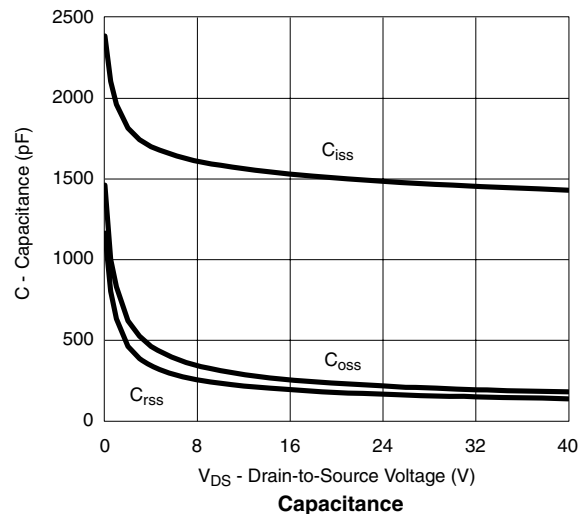
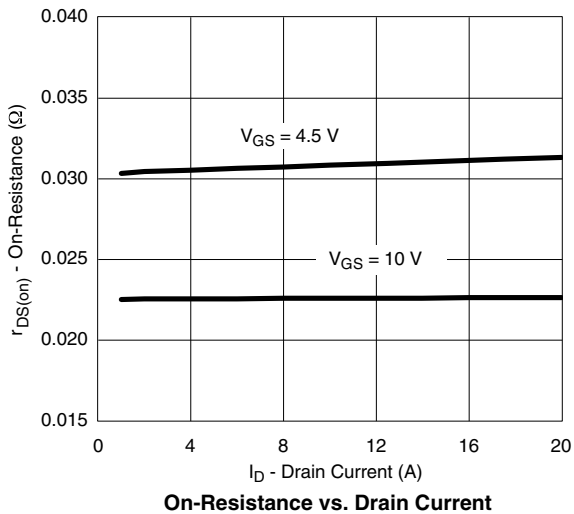
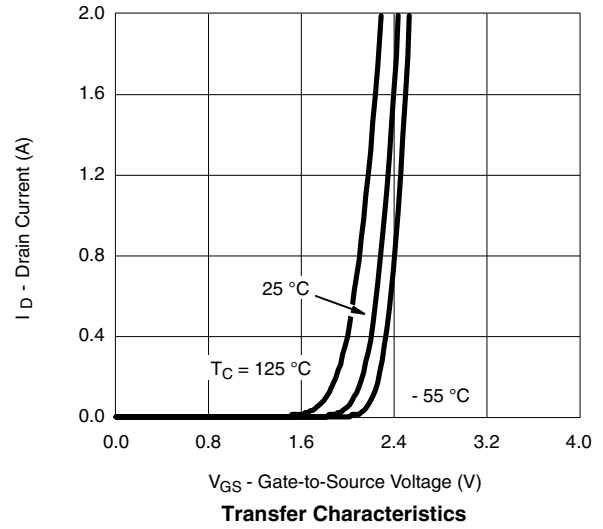
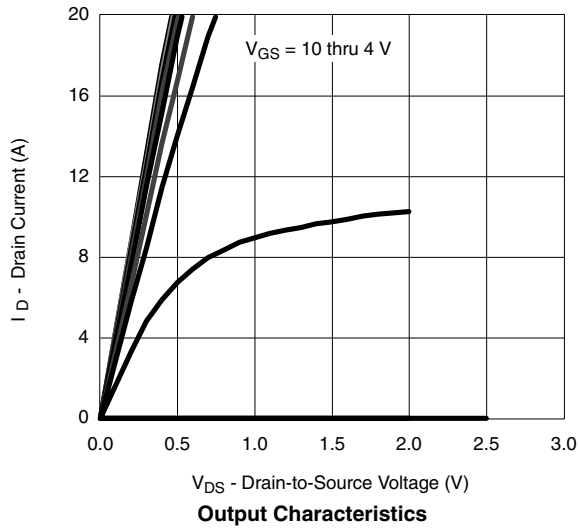


*The power dissipation P_D is based on $T_{J(max)} = 150\text{ }^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

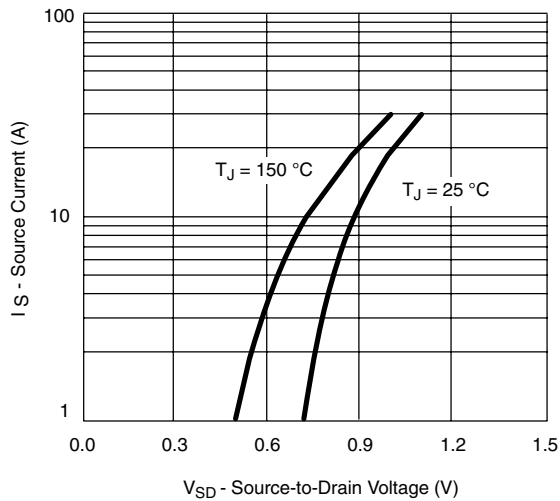
N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted



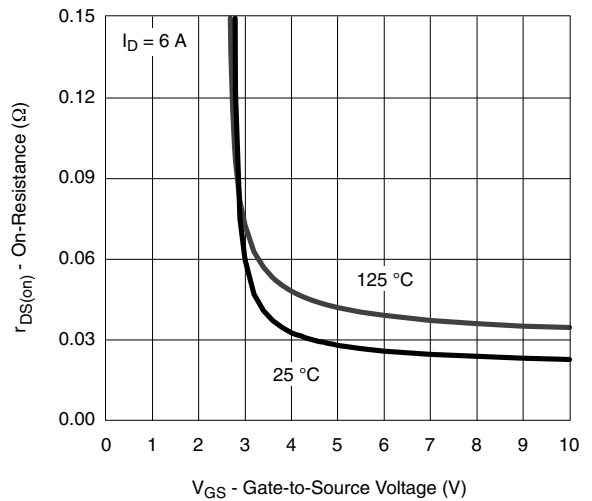
P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted



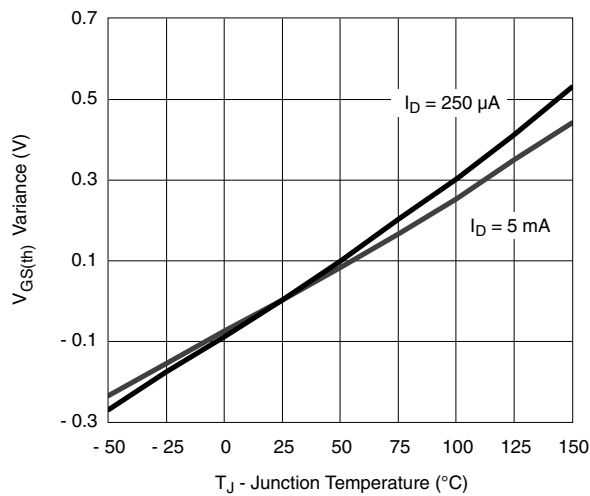
P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted



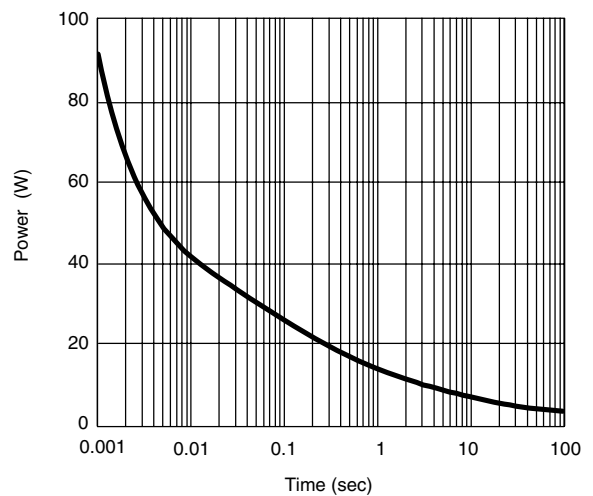
Source-Drain Diode Forward Voltage



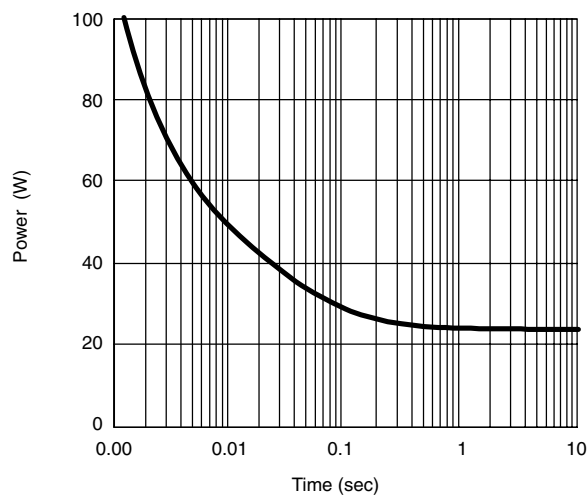
On-Resistance vs. Gate-to-Source Voltage



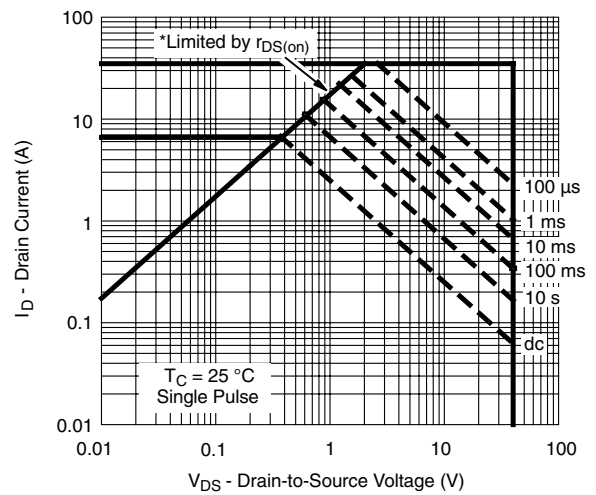
Threshold Voltage



Single Pulse Power, Junction-to-Ambient



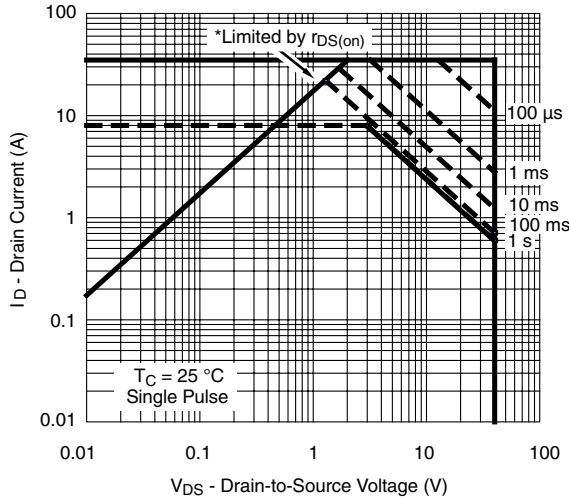
Single Pulse Power, Junction-to-Case



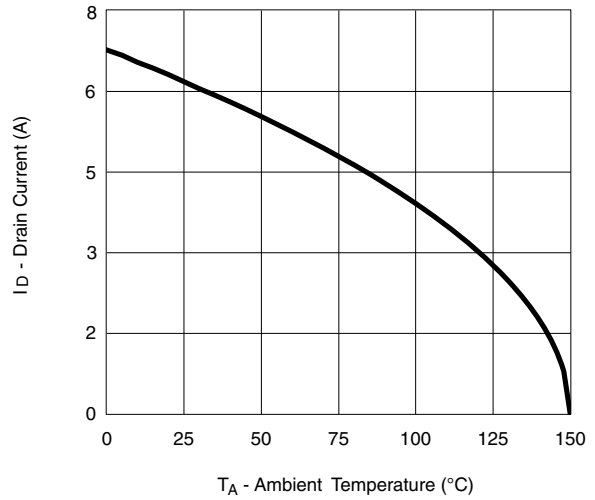
* $V_{GS} >$ minimum V_{GS} at which $r_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

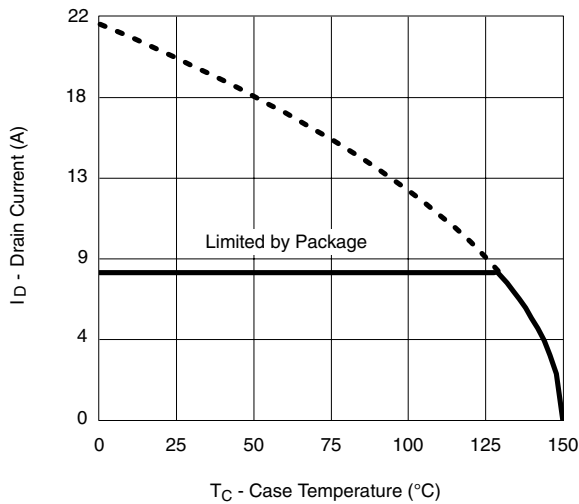
P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted



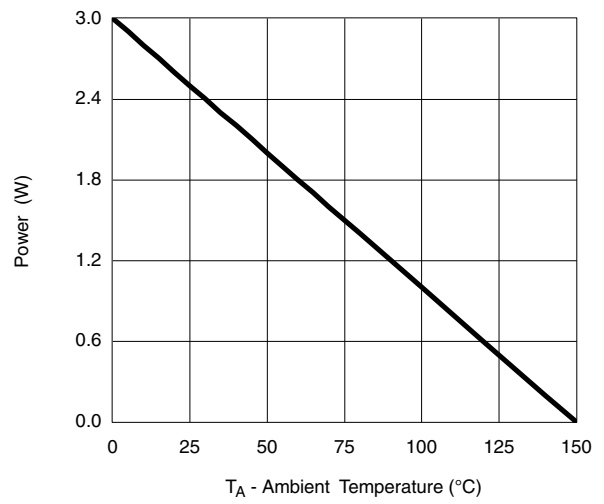
V_{DS} - Drain-to-Source Voltage (V)
 * $V_{GS} >$ minimum V_{GS} at which $r_{DS(on)}$ is specified
Safe Operating Area, Junction-to-Case



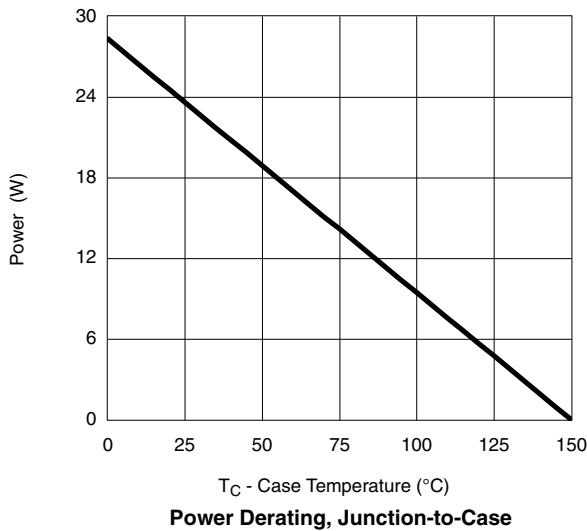
T_A - Ambient Temperature ($^{\circ}\text{C}$)
Current Derating, Junction-to-Ambient



T_C - Case Temperature ($^{\circ}\text{C}$)
Current Derating, Junction-to-Case



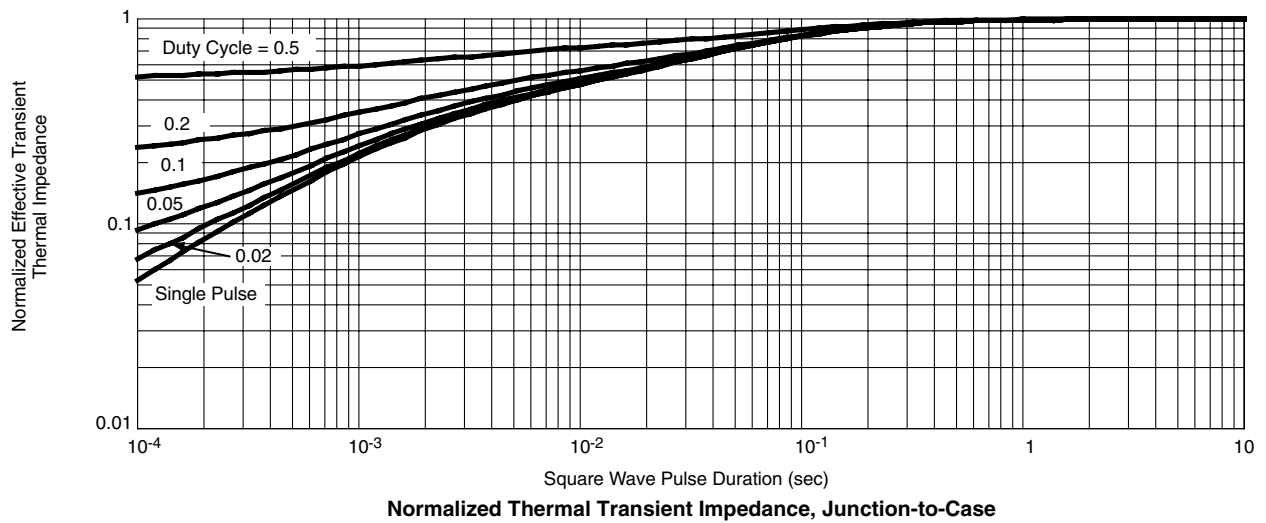
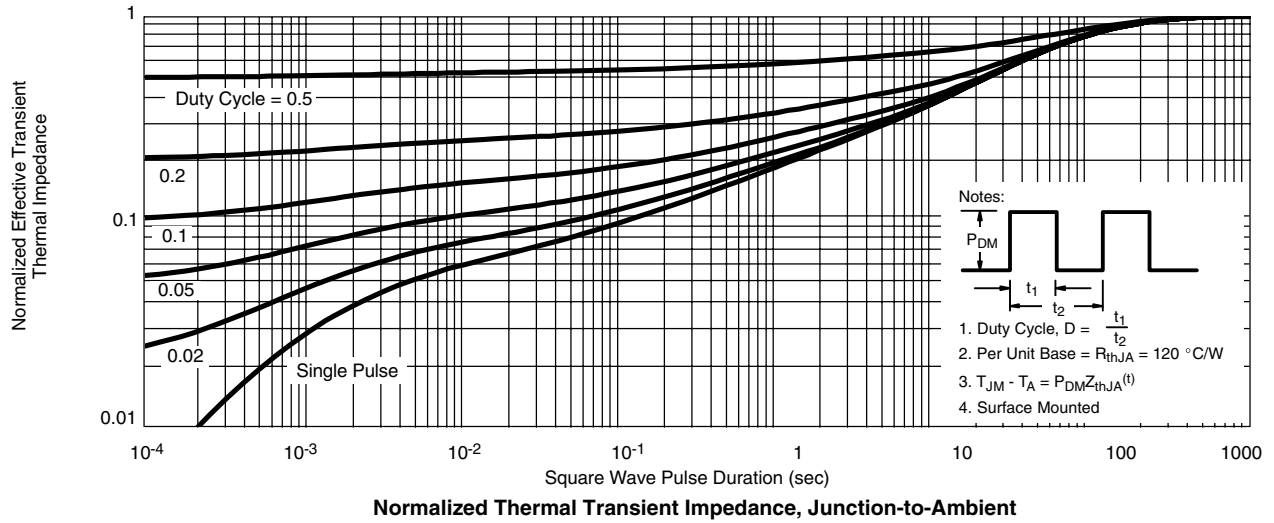
T_A - Ambient Temperature ($^{\circ}\text{C}$)
Power Derating, Junction-to-Ambient



T_C - Case Temperature ($^{\circ}\text{C}$)
Power Derating, Junction-to-Case

*The power dissipation P_D is based on $T_{J(max)} = 150\text{ °C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless noted



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- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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